

C0402C101JATACTU

General Information

Series

Style

Description

Aliases (C0402C101JATAC7867) SMD Comm X8G HT150C, Ceramic, 100 pF, 5%, 250 VDC, X8G, SMD, MLCC, High Temperature, Ultra-Stable, 0402, 0.3 mm

SMD Comm X8G HT150C

SMD, MLCC, High Temperature,

SMD Chip

Ultra-Stable



Click here for the 3D model.

Features High Temperature, Ultra-Stable RoHS Yes Termination Tin Marking No AEC-Q200 No **Typical Component Weight** 1.06 mg 78 Weeks Shelf Life MSL 1

Dimensions		
Chip Size	0402	
L	1mm +/-0.05mm	
W	0.5mm +/-0.05mm	
т	0.5mm +/-0.05mm	
S	0.3mm MIN	
В	0.3mm +/-0.1mm	

Packaging Specifications

Packaging Quantity 10000	Packaging	T&R, 180mm, Paper Tape
	Packaging Quantity	10000

Specifications	
Capacitance	100 pF
Measurement Condition	1 MHz 1.0Vrms
Tolerance	5%
Voltage DC	250 VDC
Dielectric Withstanding Voltage	625 VDC
Temperature Range	-55/+150°C
Temp. Coefficient	X8G
Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC)	30 ppm/C, 1MegaHz 1.0Vrms
Dissipation Factor	0.1% 1 MHz 1.0Vrms
Aging Rate	0% Loss/Decade Hour: Referee Time is 1000 Hours
Insulation Resistance	100 GOhms

Statements of suitability for certain applications are based on our knowledge of typical operating conditions for such applications, but are not intended to constitute – and we specifically disclaim – any warranty concerning suitability for a specific customer application or use. This Information is intended for use only by customers who have the requisite experience and capability to determine the correct products for their application. Any technical advice inferred from this Information or otherwise provided by us with reference to the use of our products is given gratis, and we assume no obligation or liability for the advice given or results obtained.